CMOS Digital Integrated Circuits Silicon Monolithic

74VHCT9273FT

1. Functional Description

• Octal D-Type Flip-Flop with Clear

2. General

The 74VHCT9273FT is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate $C^{2}MOS$ technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The input voltage are compatible with TTL output voltage.

This device may be used as a level converter for interfacing 3.3 V to 5 V system.

Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

When the $\overline{\text{CLR}}$ input is held "L", the Q outputs are at a low logic level independent of the other inputs.

The $\overline{\text{CLR}}$ input and CK input have hysteresis between the positive-going and negative-going thresholds. Thus the 74VHCT9273FT is capable of squaring up transitions of slowly changing input signals and provides an improved noise immunity.

It is easy to wire on the board because Input terminals are at the opposite side of output terminals.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage.

3. Features

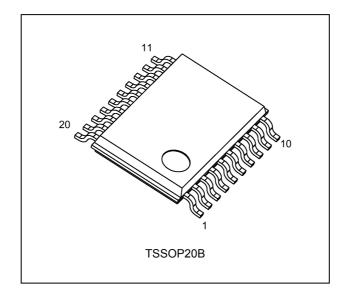
- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature range: $T_{opr} = -40$ to 125 °C
- (3) High speed: $f_{MAX} = 185$ MHz (typ.) at $V_{CC} = 5.0$ V
- (4) Low power dissipation: $I_{CC} = 2.0 \ \mu A \ (max) \ at \ T_a = 25^{\circ}C$
- (5) Compatible with TTL inputs: $V_{IL} = 0.5 V (max)$

$V_{IH} = 2.1 V (min)$

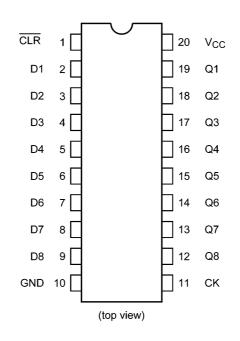
- (6) Power-down protection is provided on all inputs.
- (7) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (8) Function compatible with 74VHC273.
- (9) Input terminals are at the opposite side of output terminals
- Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

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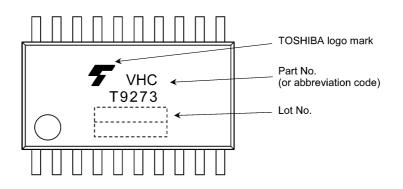
4. Packaging



5. Pin Assignment



6. Marking



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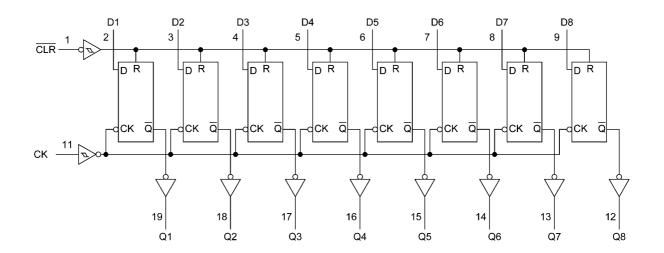
7. IEC Logic Symbol

8. Truth Table

	Inputs		Output	Function
CLR	D	СК	Q	Function
L	Х	Х	L	Clear
н	L		L	—
н	Н		Н	—
н	Х		Qn	No Change

X: Don't care

9. System Diagram



10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to 7.0	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		-20	mA
Output diode current	I _{OK}		±20	mA
Output current	I _{OUT}		±25	mA
V _{CC} /ground current	I _{CC}		±75	mA
Power dissipation	PD	(Note 1)	180	mW
Storage temperature	T _{stg}		-65 to 150	C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of $T_a = -40$ to 85 °C. From $T_a = 85$ to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

11. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	4.5 to 5.5	V
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 125	C

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Test Condition			Тур.	Max	Unit
Positive threshold voltage	VP	—		4.5	_	_	1.90	V
				5.5	_	_	2.10	
Negative threshold voltage	V _N	—		4.5	0.50	_	—	V
					0.60		_	
Hysteresis voltage	V _H			4.5	0.40	_	1.40	V
(CK,CLR)				5.5	0.40	_	1.50	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	4.5	4.4	4.5	_	V
			I _{OH} = -8 mA	4.5	3.94	—	—	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	4.5	_	0.0	0.1	V
			I _{OL} = 8 mA	4.5			0.36	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND	•	0 to 5.5	_		±0.1	μA
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	_	2.0	μA
	I _{CCT}	Per input: V_{IN} = 3.4 V Other input: V_{CC} or GND		5.5	_	_	1.35	mA

12.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit	
Positive threshold voltage	VP	—		4.5	_	1.90	V
				5.5	_	2.10	
Negative threshold voltage	V _N	_		4.5	0.50	_	V
					0.60	_	
Hysteresis voltage	V _H	_		4.5	0.40	1.40	V
(CK,CLR)				5.5	0.40	1.50	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	4.5	4.4	_	V
			I _{OH} = -8 mA	4.5	3.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	4.5	_	0.1	V
			I _{OL} = 8 mA	4.5	_	0.44	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	±1.0	μA
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	20.0	μA
	I _{CCT}	Per input: V _{IN} = 3.4 V Other input: V _{CC} or GND		5.5	_	1.50	mA

12.3. DC Characteristics (Unless otherwise specified, Ta = -40 to 125 °C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit	
Positive threshold voltage	VP	—		4.5	_	1.90	V
				5.5	_	2.10	
Negative threshold voltage	V _N	_		4.5	0.50	—	V
				5.5	0.60	—	
Hyst <u>eres</u> is voltage	V _H	_		4.5	0.40	1.40	V
(CK,CLR)				5.5	0.40	1.50	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	4.5	4.4	—	V
			I _{OH} = -8 mA	4.5	3.70	—	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	4.5	_	0.1	V
			I _{OL} = 8 mA	4.5	_	0.55	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	±2.0	μA
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	40.0	μA
	І _{ССТ}	Per input: V _{IN} = 3.4 V Other input: V _{CC} or GND		5.5	_	1.50	mA

12.4. Timing Requirements (Unless otherwise specified, $T_a = 25^{\circ}$ C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)}, t_{w(H)}$	—	5.0 ± 0.5	-	5.0	ns
Minimum pulse width (CLR)	t _{w(L)}	—	5.0 ± 0.5		5.0	ns
Minimum setup time	t _S	_	5.0 ± 0.5		4.5	ns
Minimum hold time	t _h	—	5.0 ± 0.5	_	1.0	ns
Minimum removal time (CLR)	t _{rem}	_	5.0 ± 0.5		2.0	ns

12.5. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 85°C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)}, t_{w(H)}$	—	5.0 ± 0.5	5.0	ns
Minimum pulse width (CLR)	t _{w(L)}	_	5.0 ± 0.5	5.0	ns
Minimum setup time	ts	—	5.0 ± 0.5	4.5	ns
Minimum hold time	t _h	—	5.0 ± 0.5	1.0	ns
Minimum removal time (CLR)	t _{rem}	_	5.0 ± 0.5	2.0	ns

12.6. Timing Requirements (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)}, t_{w(H)}$	—	5.0 ± 0.5	5.0	ns
Minimum pulse width (CLR)	t _{w(L)}	—	5.0 ± 0.5	5.0	ns
Minimum setup time	ts	—	5.0 ± 0.5	4.5	ns
Minimum hold time	t _h	—	5.0 ± 0.5	1.0	ns
Minimum removal time (CLR)	t _{rem}	—	5.0 ± 0.5	3.0	ns

12.7. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	$C_L (pF)$	Min	Тур.	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		—	5.0 ± 0.5	15	_	4.7	8.9	ns
(CK-Q)					50	_	7.6	14.1	
Propagation delay time	t _{PHL}		_	5.0 ± 0.5	15		7.5	14.4	ns
(CLR-Q)					50		10.4	19.6	
Maximum clock frequency	f _{MAX}		_	5.0 ± 0.5	15	110	185	_	MHz
					50	70	100	_	
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	_	5.0 ± 0.5	50	_	_	1.0	ns
Input capacitance	C _{IN}		_			_	4	10	pF
Power dissipation capacitance	C _{PD}	(Note 2)				_	13	_	pF

Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLH}m-t_{PLH}n|$, $t_{osHL} = |t_{PHL}m-t_{PHL}n|$)

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$ (per bit)

And the total C_{PD} when n pcs of flip flop operate can be gained by the following equation. C_{PD} (total) = 9 + 4 \times n

12.8. AC Characteristics

(Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	$C_L (pF)$	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		—	5.0 ± 0.5	15	1.0	10.2	ns
(CK-Q)					50	1.0	16.1	
Propagation delay time	t _{PHL}		_	5.0 ± 0.5	15	1.0	16.4	ns
(CLR-Q)					50	1.0	22.3	
Maximum clock frequency	f _{MAX}		—	5.0 ± 0.5	15	95	—	MHz
					50	60	_	
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	_	5.0 ± 0.5	50	_	1.0	ns
Input capacitance	C _{IN}						10	pF

Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLH}m-t_{PLH}n|, t_{osHL} = |t_{PHL}m-t_{PHL}n|$)

12.9. AC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		—	5.0 ± 0.5	15	1.0	11.5	ns
(CK-Q)					50	1.0	17.5	
Propagation delay time	t _{PHL}		—	5.0 ± 0.5	15	1.0	18.0	ns
(CLR-Q)					50	1.0	24.5	
Maximum clock frequency	f _{MAX}		_	5.0 ± 0.5	15	85		MHz
					50	55		
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	—	5.0 ± 0.5	50		1.0	ns
Input capacitance	C _{IN}		_			_	10	рF

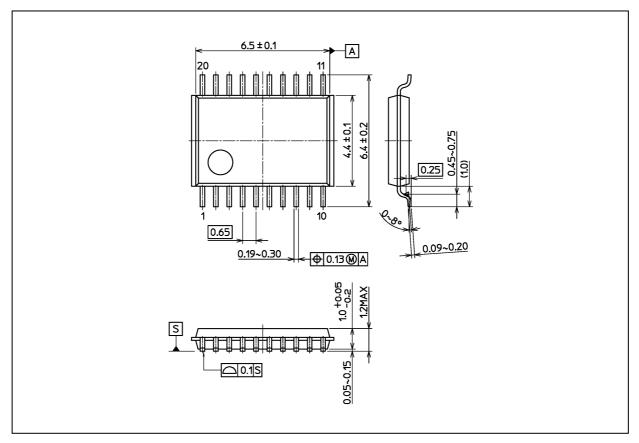
Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLH}m-t_{PLH}n|$, $t_{osHL} = |t_{PHL}m-t_{PHL}n|$)



74VHCT9273FT

Package Dimensions

Unit: mm



Weight: 0.071 g (typ.)

	Package Name(s)		
Nickname: TSSOP20B			

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